

PNP SILICON PLANAR MEDIUM POWER TRANSISTORS IN SOT89

Features

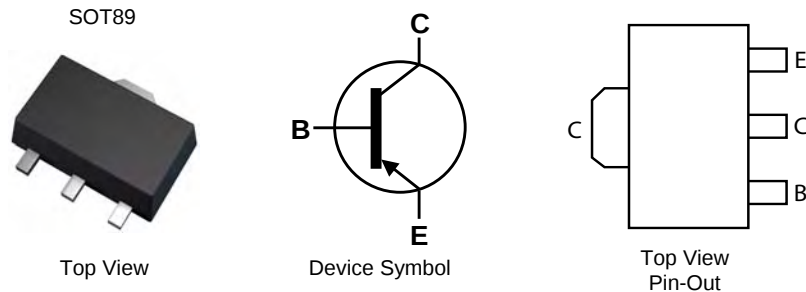
- $I_C = -1A$ Continuous Collector Current
- Low Saturation Voltage $V_{CE(sat)} < -500mV$ @ $-0.5A$
- Gain groups 10 and 16
- Epitaxial Planar Die Construction
- Complementary NPN types: BCX54, 55, and 56
- **Lead-Free, RoHS Compliant (Note 1)**
- **Halogen and Antimony Free. "Green" Devices (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic, "Green" Molding Compound (Note 2)
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.072 grams (Approximate)

Applications

- Medium Power Switching or Amplification Applications
- AF driver and output stages

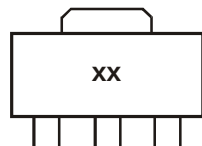


Ordering Information (Note 3)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
BCX51TA	AA	7	12	1,000
BCX5110TA	AC	7	12	1,000
BCX5116TA	AD	7	12	1,000
BCX52TA	AE	7	12	1,000
BCX5210TA	AG	7	12	1,000
BCX5216TA	AM	7	12	1,000
BCX53TA	AH	7	12	1,000
BCX5310TA	AK	7	12	1,000
BCX5316TA	AL	7	12	1,000
BCX5316TC	AL	13	12	4,000
BCX5316-13R	AL	13	12	4,000

- Notes:
1. No purposefully added lead.
 2. Diodes Inc's "Green" Policy can be found on our website at <http://www.diodes.com>
 3. For packaging details, go to our website <http://www.diodes.com>

Marking Information



xx = Product Type Marking Code, as follows:

BCX51 = AA
BCX5110 = AC
BCX5116 = AD

BCX52 = AE
BCX5210 = AG
BCX5316 = AM

BCX53 = AH
BCX5310 = AK
BCX5316 = AL

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

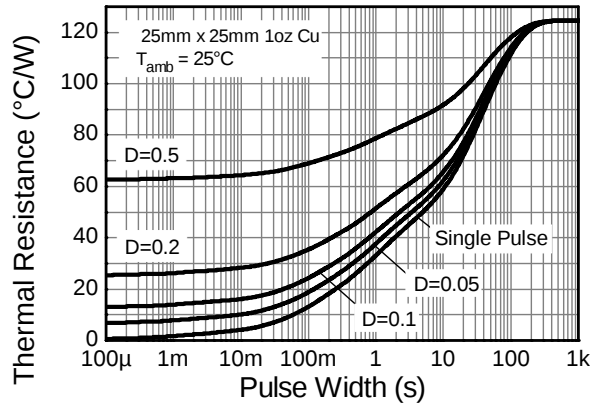
Characteristic	Symbol	BCX51	BCX52	BCX53	Unit
Collector-Base Voltage	V _{CBO}	-45	-60	-100	V
Collector-Emitter Voltage	V _{CEO}	-45	-60	-80	V
Emitter-Base Voltage	V _{EBO}	-5			V
Continuous Collector Current	I _C	-1			A
Peak Pulse Collector Current	I _{CM}	-1.5			
Continuous Base Current	I _B	-100			mA
Peak Pulse Base Current	I _{BM}	-200			

Thermal Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

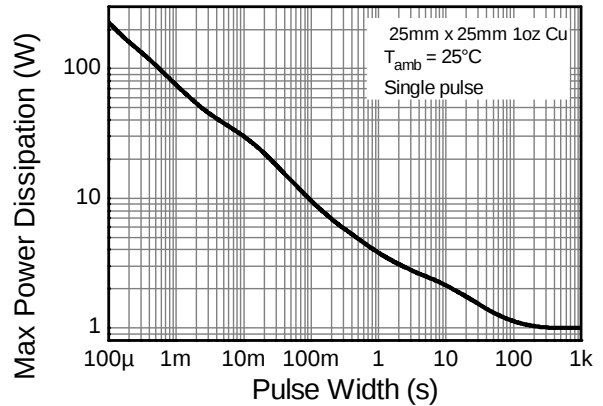
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P_D	1	W
Thermal Resistance, Junction to Ambient (Note 4)	$R_{\theta JA}$	124	$^\circ\text{C/W}$
Thermal Resistance, Junction to Leads (Note 5)	$R_{\theta JL}$	10.0	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

- Notes:
4. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 5. Thermal resistance from junction to solder-point (on the exposed collector pad).

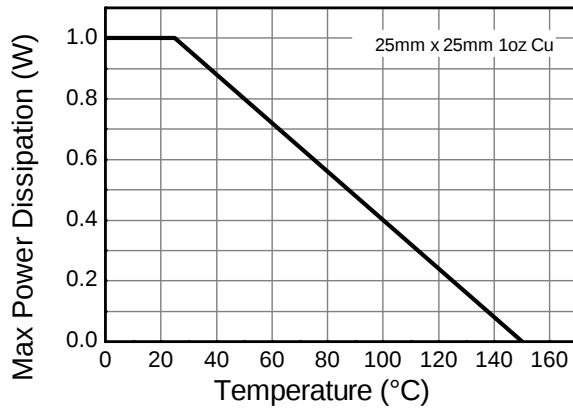
Thermal Characteristics



Transient Thermal Impedance



Pulse Power Dissipation



Derating Curve

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	-45	-	-	V	$I_C = -100\mu\text{A}$
		-60				
		-100				
Collector-Emitter Breakdown Voltage (Note 6)	BV_{CEO}	-45	-	-	V	$I_C = -10\text{mA}$
		-60				
		-80				
Emitter-Base Breakdown Voltage	BV_{EBO}	-5	-	-	V	$I_E = -10\mu\text{A}$
Collector Cut-off Current	I_{CBO}	-	-	-0.1 -20	μA	$V_{CB} = -30\text{V}$ $V_{CB} = -30\text{V}, T_A = 150^\circ\text{C}$
Emitter Cut-off Current	I_{EBO}	-	-	-20	nA	$V_{EB} = -4\text{V}$
Static Forward Current Transfer Ratio (Note 6)	h_{FE}	25	-	-		$I_C = -5\text{mA}, V_{CE} = -2\text{V}$
		40	-	250		$I_C = -150\text{mA}, V_{CE} = -2\text{V}$
		25	-	-		$I_C = -500\text{mA}, V_{CE} = -2\text{V}$
		63	-	160		$I_C = -150\text{mA}, V_{CE} = -2\text{V}$
		100	-	250		$I_C = -150\text{mA}, V_{CE} = -2\text{V}$
Collector-Emitter Saturation Voltage (Note 6)	$V_{CE(sat)}$	-	-	-0.5	V	$I_C = -500\text{mA}, I_B = -50\text{mA}$
Base-Emitter Turn-On Voltage (Note 6)	$V_{BE(on)}$	-	-	-1.0	V	$I_C = -500\text{mA}, V_{CE} = -2\text{V}$
Transition Frequency	f_T	150	-	-	MHz	$I_C = -50\text{mA}, V_{CE} = -10\text{V}$ $f = 100\text{MHz}$
Output Capacitance	C_{obo}	-	-	25	pF	$V_{CB} = -10\text{V}, f = 1\text{MHz}$

Notes: 6. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$.

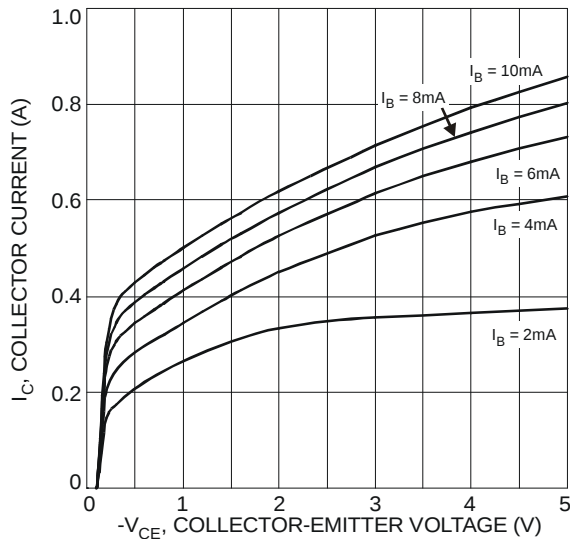


Fig. 1 Typical Collector Current vs. Collector-Emitter Voltage

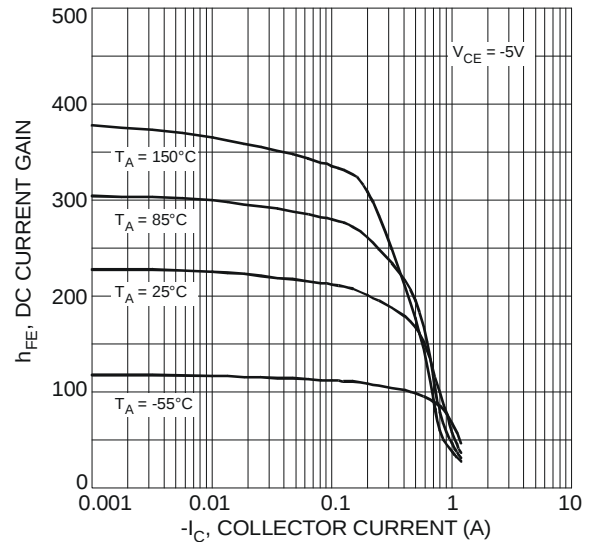


Fig. 2 Typical DC Current Gain vs. Collector Current

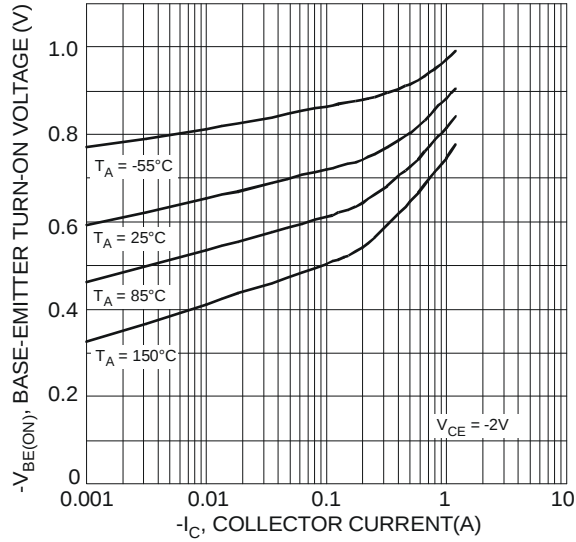


Fig 3 Typical Base-Emitter Turn-On Voltage vs. Collector Current

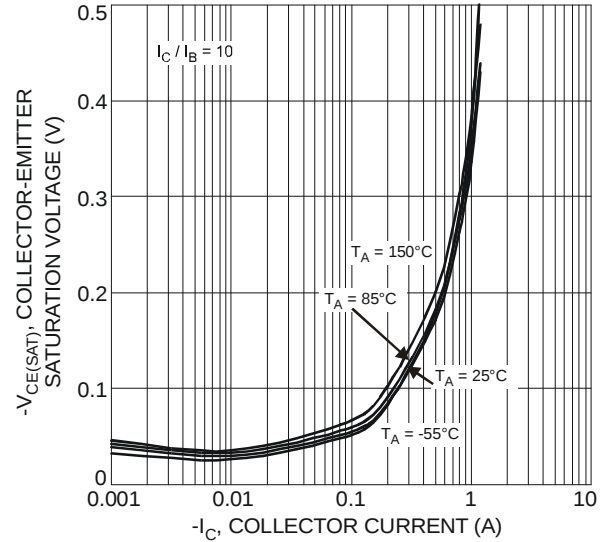


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

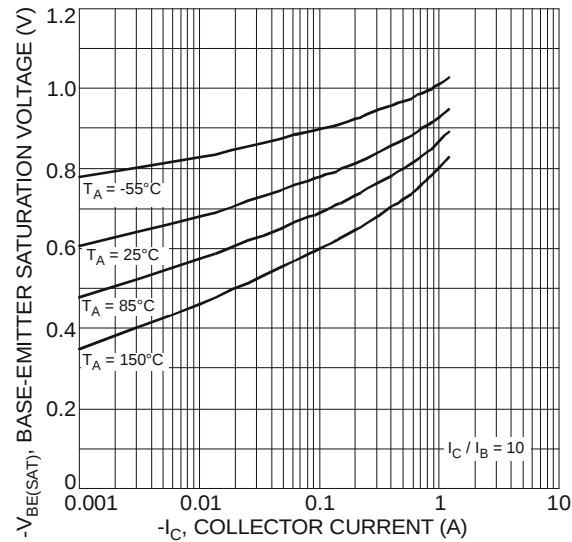


Fig. 5 Typical Base-Emitter Saturation Voltage vs. Collector Current

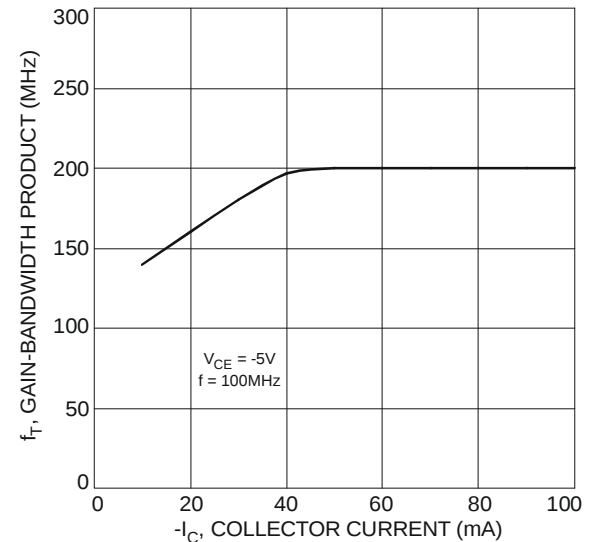


Fig. 6 Typical Gain-Bandwidth Product vs. Collector Current

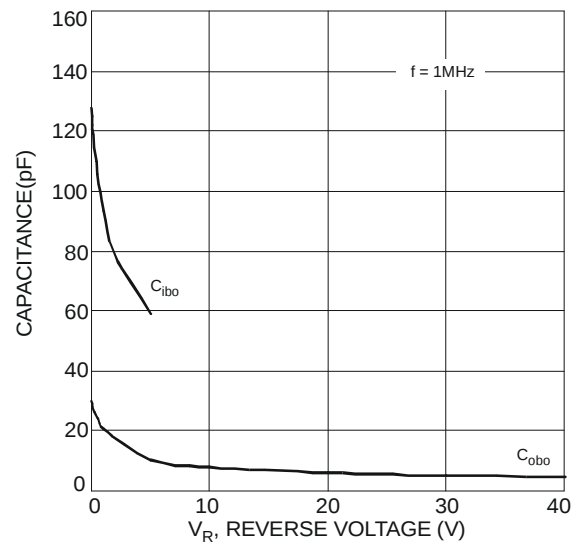
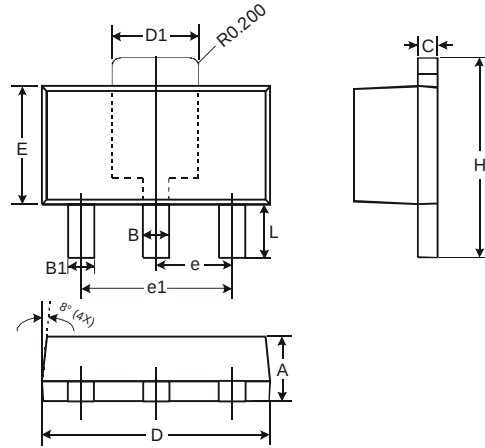


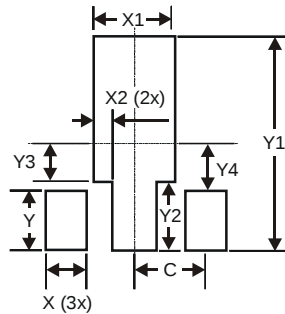
Fig. 7 Typical Capacitance Characteristics

Package Outline Dimensions



SOT89		
Dim	Min	Max
A	1.40	1.60
B	0.44	0.62
B1	0.35	0.54
C	0.35	0.43
D	4.40	4.60
D1	1.52	1.83
E	2.29	2.60
e	1.50 Typ	
e1	3.00 Typ	
H	3.94	4.25
L	0.89	1.20
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
X	0.900
X1	1.733
X2	0.416
Y	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
C	1.500

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